TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74VHC595FN

8-Bit Shift Register/Latch (3-state)

The TC74VHC595 is an advanced high speed 8-BIT SHIFT REGISTER/LATCH fabricated with silicon gate $\rm C^2MOS$ technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

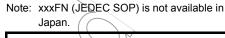
The TC74VHC595 contains an 8-bit static shift register which feeds an 8-bit storage register.

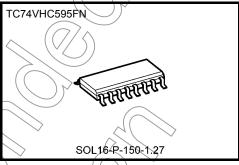
Shift operation is accomplished on the positive going transition of the SCK input. The output register is loaded with the contents of the shift register on the positive going transition of the RCK input. Since RCK and SCK signal are independent, parallel outputs can be held stable during the shift operation. And, since the parallel outputs are 3-state, it can be directly connected to 8-bit bus. This register can be used in serial-to-parallel conversion, data receivers, etc.

An input protection circuit ensures that 0 to $5.5 \, V$ can be applied to the input pins without regard to the supply voltage. This device can be used to interface $5 \, V$ to $3 \, V$ systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

Features

- High speed: $f_{max} = 185 \text{ MHz}$ (typ.) at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 4 \mu A$ (max) at $T_{CC} = 25$ °C
- High noise immunity: $V_{NIH} = V_{NHL} = 28\% V_{CC}$ (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays; tpLH = tpHL
- Wide operating voltage range: VCC (opr) = 2 V to 5.5 V
- Low noise: VOLP = 1.0 V (max)
- Pin and function compatible with 74ALS595



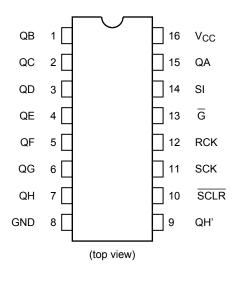


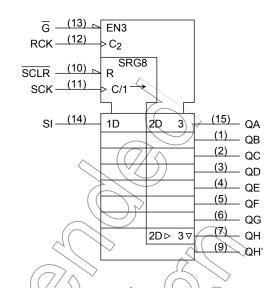
Weight 🛆

SOL16-P-150-1.27 //: 0.13 g (typ.)

Pin Assignment

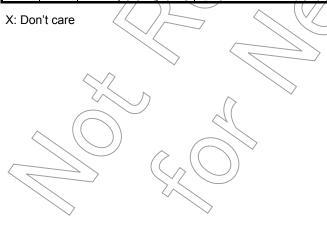
IEC Logic Symbol



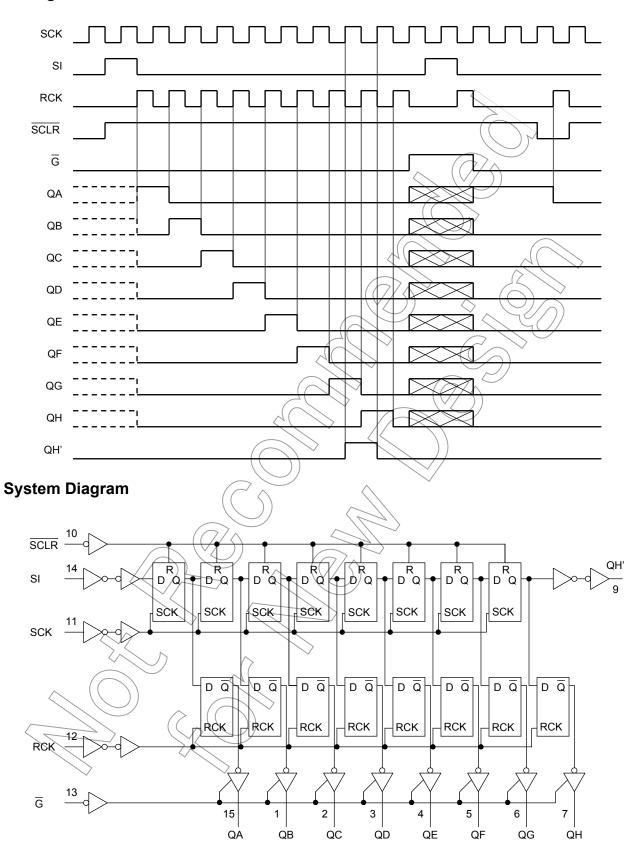


Truth Table

| | | Inputs | | | Function |
|----|--------|--------|-----|---|---|
| SI | SCK | SCLR | RCK | G | Pulicuon |
| Х | Х | Х | Х | Н | QA thru QH outputs disable |
| Х | Х | Х | Х | L | QA thru QH outputs enable |
| Х | Х | L | Х | Х | Shift register is cleared |
| L | | Н | Х | Х | First stage of S.R. becomes "L". Other stages store the data of previous stage, respectively. |
| Н | | Н | Х | Х | First stage of S.R. becomes "H". Other stages store the data of previous stage, respectively. |
| Х | \Box | Н | Х | Х | State of S.R. is not changed: |
| Х | Х | Х | | X | S.R. data is stored into storage register. |
| Х | Х | Х | | × | Storage register stage is not changed. |



Timing Chart



Absolute Maximum Ratings (Note)

| Characteristics | Symbol | Rating | Unit |
|------------------------------------|------------------|-------------------------------|-------|
| Supply voltage range | V _{CC} | −0.5 to 7.0 | V |
| DC input voltage | V _{IN} | −0.5 to 7.0 | V |
| DC output voltage | V _{OUT} | -0.5 to V _{CC} + 0.5 | V |
| Input diode current | lik | -20 | mA |
| Output diode current | I _{OK} | ±20 | mA |
| DC output current | I _{OUT} | ±25 | mA |
| DC V _{CC} /ground current | Icc | ±75 |)) mA |
| Power dissipation | PD | 180 | mW |
| Storage temperature | T _{stg} | -65 to 150 | °C |

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Ranges (Note)

| Characteristics | Symbol | Rating | Unit |
|--------------------------|---------------------|---|------|
| Supply voltage | Vec | 2.0 to 5.5 | V |
| Input voltage | ((VIN | 0 to 5.5 | V |
| Output voltage | Vout | 0 to Voc | V |
| Operating temperature | // T _{opr} | =40 to 85 | °C |
| Input rise and fall time | dt/dv 〈 | 0 to 100 ($V_{CC} = 3.3 \pm 0.3 \text{ V}$) 0 to 20 ($V_{CC} = 5 \pm 0.5 \text{ V}$) | ns/V |

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.





Electrical Characteristics

DC Characteristics

| Characteristics | Symbol | Test Condition | | V _{CC} | - | Га = 25°(| | Ta −40 to | | Unit |
|----------------------------------|-----------------|---|--|-------------------|----------------------------------|-------------------|----------------------|----------------------------------|----------------------------------|----------|
| onarasione | - Cy20. | | | | Min | Тур. | Max | Min | Max | |
| High-level input voltage | V _{IH} | _ | | | 1.50 V _{CC} × 0.7 | (| | 1.50 V _{CC} × 0.7 | 1 1 | ٧ |
| Low-level input voltage | V _{IL} | _ | | | -(| | 0.50 Vec × 0.3 | _ | 0.50 V _{CC} × 0.3 | V |
| High-level output voltage | Vон | V _{IN} = V _{IH} or V _{IL} | I _{OH} = -50 μA | 2.0 3.0 4.5 | 1.9 2.9 4.4 | 2.0 3.0 4.5 | _ _ _ | 1.9 | 1 //>1 | V |
| - | | | $I_{OH} = -4 \text{ mA}$ $I_{OH} = -8 \text{ mA}$ | 3.0 4.5 | 2.58 3.94 | _< | | 2.48 | > —) — | |
| Low-level output voltage | V _{OL} | V _{IN} = V _{IH} or | Ι _{ΟL} = 50 μΑ | 2.0 3.0 4.5 | _ | 0.0 0.1 - |) - - | 0.1 0.1 0.1 | V | |
| voltage | | VIL | I _{OL} = 4 mA I _{OL} = 8 mA | 3.0 4.5 | - | | 0.36 0.36 | _ _ | 0.44 0.44 | |
| 3-state output off-state current | I _{OZ} | V _{IN} = V _{IH} or V _{IL} V _{OUT} = V _{CC} or GND | | 5.5 | |)) | ±0.25 | _ | ±2.50 | μΑ |
| Input leakage current | I _{IN} | V _{IN} ≠ 5.5 V or GND | | 0 to 5.5 | _ | _ | ±0.1 | _ | ±1.0 | μΑ |
| Quiescent supply current | Icc | VIN = VC | VIN = VGC OF GND | | | _ | 4.0 | _ | 40.0 | μΑ |



Timing Requirements (input: $t_r = t_f = 3 \text{ ns}$)

| Characteristics | Symbol Test Condition | | | Ta = 25°C | | Ta = -40 to 85°C | Unit |
|----------------------|-----------------------|---|---------------------|---------------------------|-------|------------------------|------|
| | | | V _{CC} (V) | Тур. | Limit | Limit | |
| Minimum pulse width | t _{w (H)} | | 3.3 ± 0.3 | _ | 5.0 | 5.0 | ns |
| (SCK, RCK) | t _{w (L)} | _ | 5.0 ± 0.5 < | 1 | 5.0 | 5.0 | 115 |
| Minimum pulse width | 4 | | 3.3 ± 0.3 | / | 5.0 | 5.0 | ns |
| (SCLR) | t _{w (L)} | _ | 5.0 ± 0.5 | (-) | 5.0 | 5.0 | 115 |
| Minimum set-up time | + | | 3.3 ± 0.3 | | 3.5 | 3.5 | ns |
| (SI-SCK) | t _S | _ < | 5.0 ± 0.5 | $\langle \cdot \rangle$ | 3.0 | 3.0 | 115 |
| Minimum set-up time | t _s | | 3.3 ± 0.3 | | 8.0 | 8.5 | ns |
| (SCK-RCK) | ις | _ | 5.0 ± 0.5 | <u> </u> | 5.0 | 5.0 | 115 |
| Minimum set-up time | + | | 3.3 ± 0.3 | _ | 8.0 | 9.0 | ns |
| (SCLR-RCK) | t _S | _ </td <td>5.0 ± 0.5</td> <td>_</td> <td>5.0</td> <td>5.0</td> <td>115</td> | 5.0 ± 0.5 | _ | 5.0 | 5.0 | 115 |
| Minimum hold time | t _h | | 3.3 ± 0.3 | -5 | 1.5 | 1.5 | ns |
| (SI-SCK) | чh | - ((// \(\) | 5.0 ± 0.5 | +(| 2.0 | 2.0 | 115 |
| Minimum hold time | +. | | 3.3 ± 0.3 | (7 | (ø) | 0 | ns |
| (SCK-RCK) | t _h | 7 | 5.0 ± 0.5 |) } | >0 | 0 | 115 |
| Minimum hold time | t. | 4() | 3.3 ± 0.3 | /) | 0 | 0 | ns |
| (SCLR-RCK) | t _h | | 5,0 ± 0.5 | | 0 | 0 | 115 |
| Minimum removal time | + | | 3.3 ± 0.3 |) — | 3.0 | 3.0 | no |
| (SCLR) | t _{rem} | 4(> | 5.0 ± 0.5 | _ | 2.5 | 2.5 | ns |



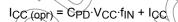


AC Characteristics (input: $t_r = t_f = 3 \text{ ns}$)

| Characteristics | Symbol | Test Condition | | | Ta = 25°C | | | Ta −40 to | Unit | |
|-------------------------------|------------------|-----------------------|---------------------|---------------------|-----------|------|-------------|--------------|--------|-------|
| 5.1a. astoe.s | 5, | | V _{CC} (V) | C _L (pF) | Min | Тур. | Max | Min | Max | J |
| | | | 3.3 ± 0.3 | 15 | _ | 8.8 | 13.0 | 1.0 | 15.0 | |
| Propagation delay time | t _{pLH} | | 3.3 ± 0.3 | 50 | _ | 11.3 | 16.5 | 1.0 | 18.5 | ns |
| (SCK-QH') | t _{pHL} | _ | 5.0 ± 0.5 | 15 | _ | 6.2 | 8.2 | 1.0 | 9.4 | 115 |
| , , | | | 5.0 ± 0.5 | 50 | _ | 7.7 | 10.2 | 1.0 | 11.4 | |
| | | | 3.3 ± 0.3 | 15 | _ | 8.4 | 12.8 | 1.0 | 13.7 | |
| Propagation delay time | | | 3.3 ± 0.3 | 50 | _ | 10.9 | 16.3 | 1.0 | 17.2 | ne |
| (SCLR-QH') | t _{pHL} | _ | 5.0 ± 0.5 | 15 | - | 5.9 | 8.0 | 1.0 | 9.1 | ns |
| , | | | 3.0 ± 0.3 | 50 | -((| 7.4 | 10.0 | 1.0 | 11.1 | |
| | | | 3.3 ± 0.3 | 15 | | 7.1 | 11.9 | 1.0 | 13.5 | - ns |
| Propagation delay time | t _{pLH} | | | 50 < | 1(-/ | 10.2 | 15.4 | 1.0 | 17.0 | |
| (RCK-Q _n) | t _{pHL} | | 5.0 ± 0.5 | 15 | Ú, | 5.4 | 7.4 | 10 | 8.5 | |
| | | | | 50 | \ \ | 6.9 | 9.4 | 1.0 | 10.5 | |
| | t _{pZL} | R _L = 1 kΩ | 3.3 ± 0.3 | 15 | | 7.5 | (11.5 | (1,0) |) 13.5 | - ns |
| Output enable time | | | | 50 | _ | 9.0 | 15.0 | 1.0 | 17.0 | |
| Output enable time | t _{pZH} | | 5.0 ± 0.5 | 15 | _ | 4.8 | 8.6 | 1.0 | 10.0 | |
| | | | | 50 | _ | 8.3 | 10.6 | 1.0 | 12.0 | |
| Output disable time | t _{pLZ} | R _L = 1 kΩ | 3.3 ± 0.3 | > 50 | | 12.1 |) 15.7 | 1.0 | 16.2 | ns |
| Output disable time | t _{pHZ} | | 5.0 ± 0.5 | 50 // | | 7.6 | 10.3 | 1.0 | 11.0 | 115 |
| | | | 3.3 ± 0.3 | 15 | 80 | 150 | _ | 70 | _ | - MHz |
| Maximum clock | f _{max} | | 3.5 ± 0.5 | 50 | 55 | /130 | _ | 50 | _ | |
| frequency | ımax | | 5.0 ± 0.5 | 15 | 135 | 185 | _ | 115 | | |
| | | ((| | 50 | 95 | 155 | _ | 85 | _ | |
| Input capacitance | C _{IN} | | | 1/2 | > _ | 4 | 10 | _ | 10 | pF |
| Output capacitance | CONT | (/)) | - (| 1 | _ | 6 | _ | _ | 1 | pF |
| Power dissipation capacitance | СРВ | | | (Note) | _ | 87 | _ | _ | _ | pF |

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

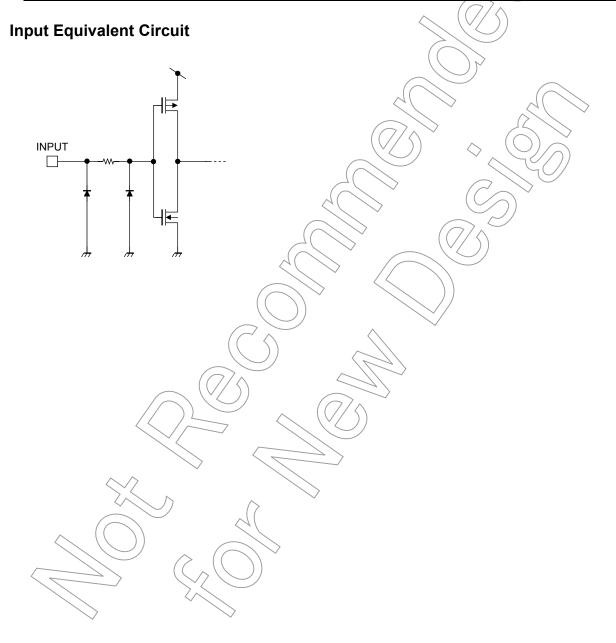
Average operating current can be obtained by the equation:





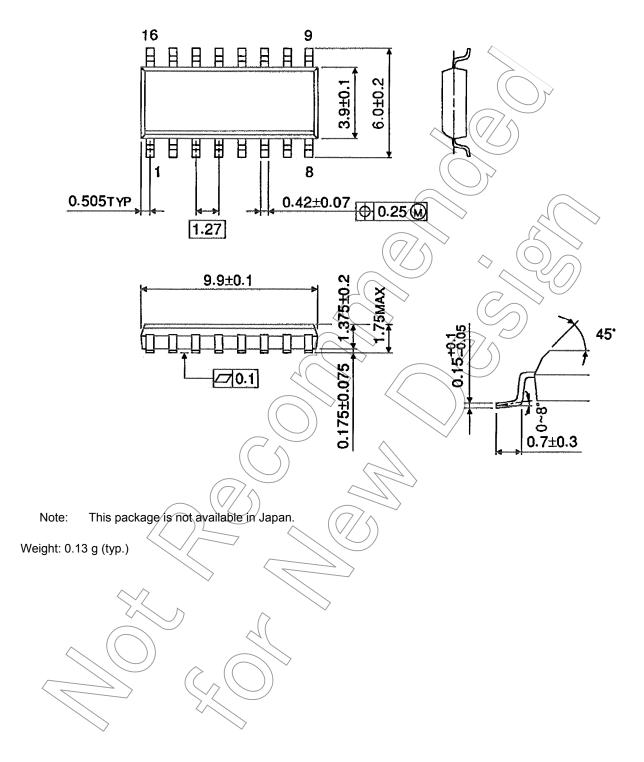
Noise Characteristics (input: tr = tf = 3 ns)

| Characteristics | Symbol | Test Condition | | Ta = 25°C | | - Unit |
|--|------------------|------------------------|---------------------|-----------|-------|--------|
| Characteristics | Symbol | Test Condition | V _{CC} (V) | Тур. | Limit | Offic |
| Quiet output maximum dynamic V _{OL} | V _{OLP} | C _L = 50 pF | 5.0 | 0.8 | 1.0 | V |
| Quiet output minimum dynamic V _{OL} | V _{OLV} | C _L = 50 pF | 5.0 | -0.8 | -1.0 | V |
| Minimum high level dynamic input voltage | V _{IHD} | C _L = 50 pF | 5.0 | _ | 3.5 | V |
| Maximum low level dynamic input voltage | V _{ILD} | C _L = 50 pF | 5.0 |) >- | 1.5 | V |



Package Dimensions (Note)

SOL16-P-150-1.27 Unit: mm



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